



Cristian Pira



SRF cavities  
R&D for  
FCC-ee

INFN Accelerators European  
Strategy Program

Work supported by INFN CSN5 experiment SAMARA and INFN CSN1 experiments SRF and RD\_FCC

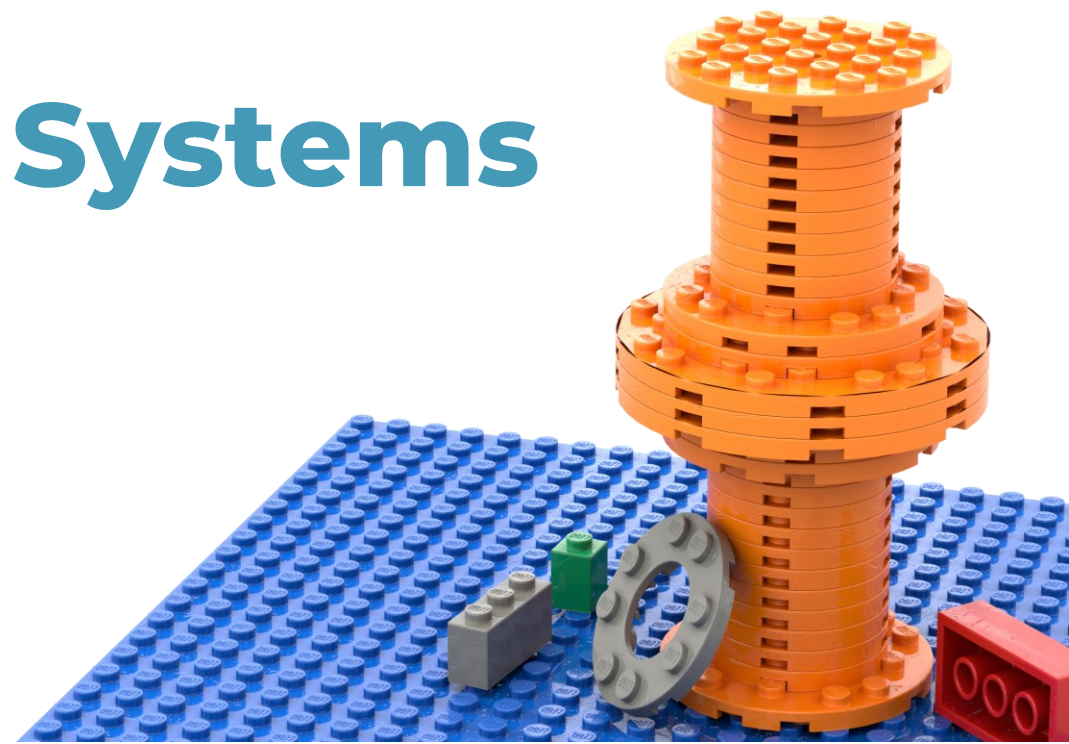


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# Developments Towards Energy Efficient Superconducting RF Systems



**7th Workshop**  
**Energy for Sustainable Science**  
**at Research Infrastructures.**  
September 25th to 27th - Madrid, Spain



# Key word: sustainability



European Union



United Nations



**Save energy**



**Reduce resources consumption and waste production**



**Clean and green procedures**

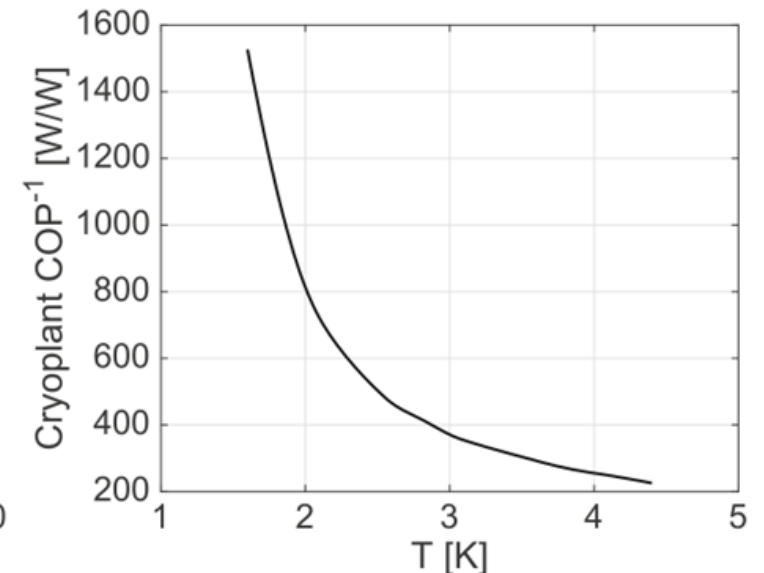
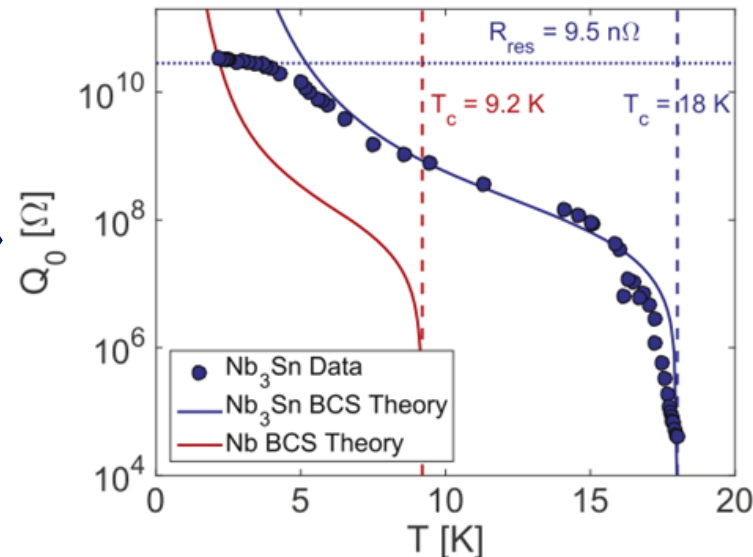
# Nb<sub>3</sub>Sn motivation

**Energy saving** is mandatory for the **next generation accelerators**

**Cryogenics** is one of the **larger energy cost** in modern SRF accelerators

➔ Move from **bulk Nb @2K** to **Nb<sub>3</sub>Sn @4.5 K**  
reduces cryogenic power by a factor of 3

7.5 GeV LINAC new construction

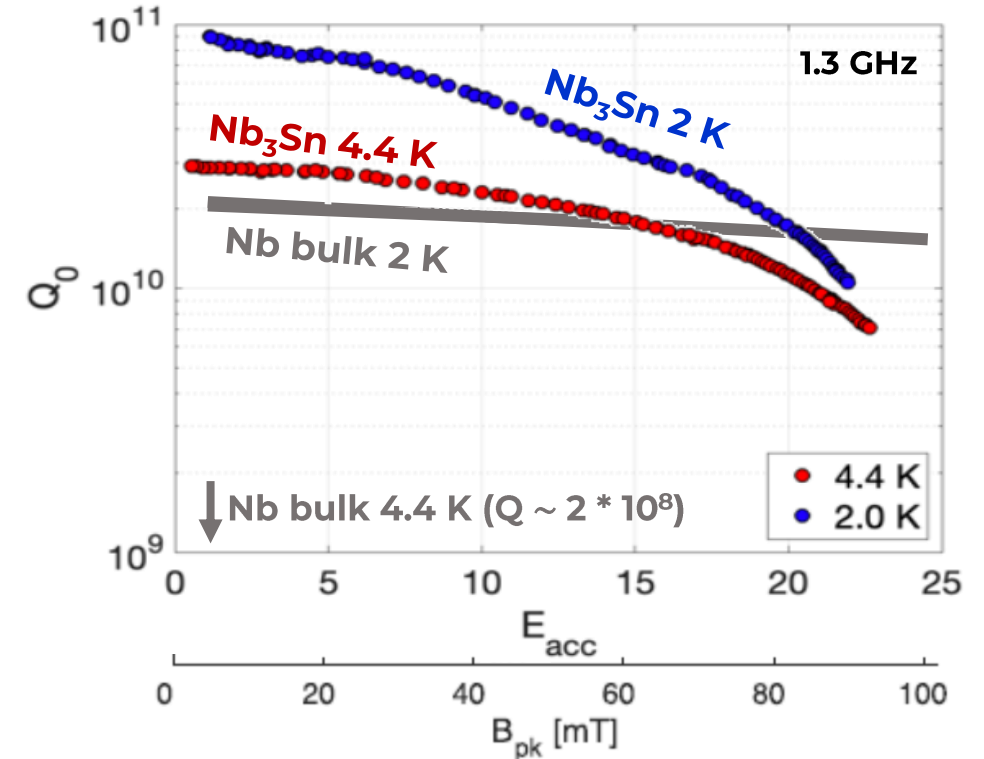
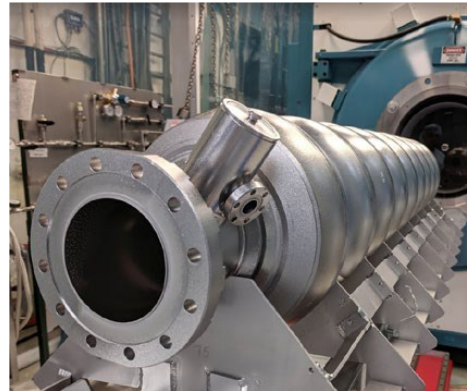
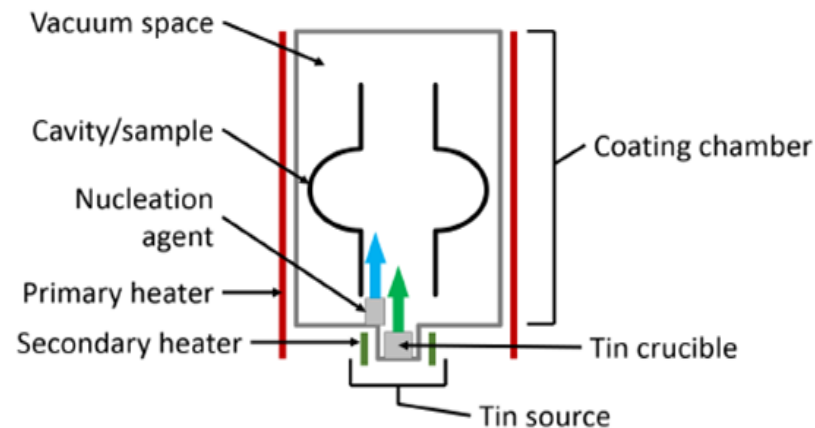


Supercond. Sci. Technol. 30 (2017) 033004

# Nb<sub>3</sub>Sn state of the art

## Vapor Tin Diffusion

Cornell, Fermilab, JLab, KEK



S. Posen, SRF 2019 proceedings (elaborated)

## Technology limitation:

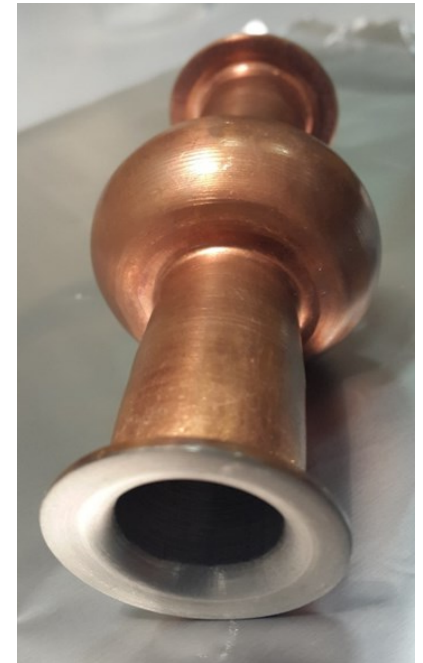
- ▶ **Reproducibility**
- ▶ **Nb as Substrate** (expensive, chemistry, no interlayer possible)

# A different approach: Nb<sub>3</sub>Sn on Cu



## Cu substrate as several advantages:

- ▶ **Cheaper** than Nb
- ▶ Higher **thermal conductivity**
- ▶ Higher **mechanical stability**
- ▶ Low **carbon footprint**
- ▶ **PVD technology** (Nb on Cu) already used for LEP, LHC, HIE-ISOLDE @ CERN  
ALPI @ INFN LNL





# Nb<sub>3</sub>Sn on Cu: Multiple challenges

- ▶ A15 are Brittle materials
- ▶ Complicated Phase Diagram
- ▶ Low melting point substrate
- ▶ Interface diffusion
- ▶ Coating Parameters
- ▶ Substrate preparation
- ▶ Target Production/Magnetron Design
- ▶ Trapped Flux
- ▶ Tuning



# Nb<sub>3</sub>Sn on Cu: Multiple challenges

- ▶ Al5 are Brittle materials
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# Collaboration



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D. Longuevergne, O. Hryhorenko,



S. Keckert, O. Kugeler, J. Knobloch



S. Prucnal, S. Zhou



X. Jiang, T. Staedler, A. Zbtsovskii



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W. Bradley, S. Simon



R. Berton, D. Piccoli, F. Piccoli, G. Squizzato, F. Telatin

## Associated Partners

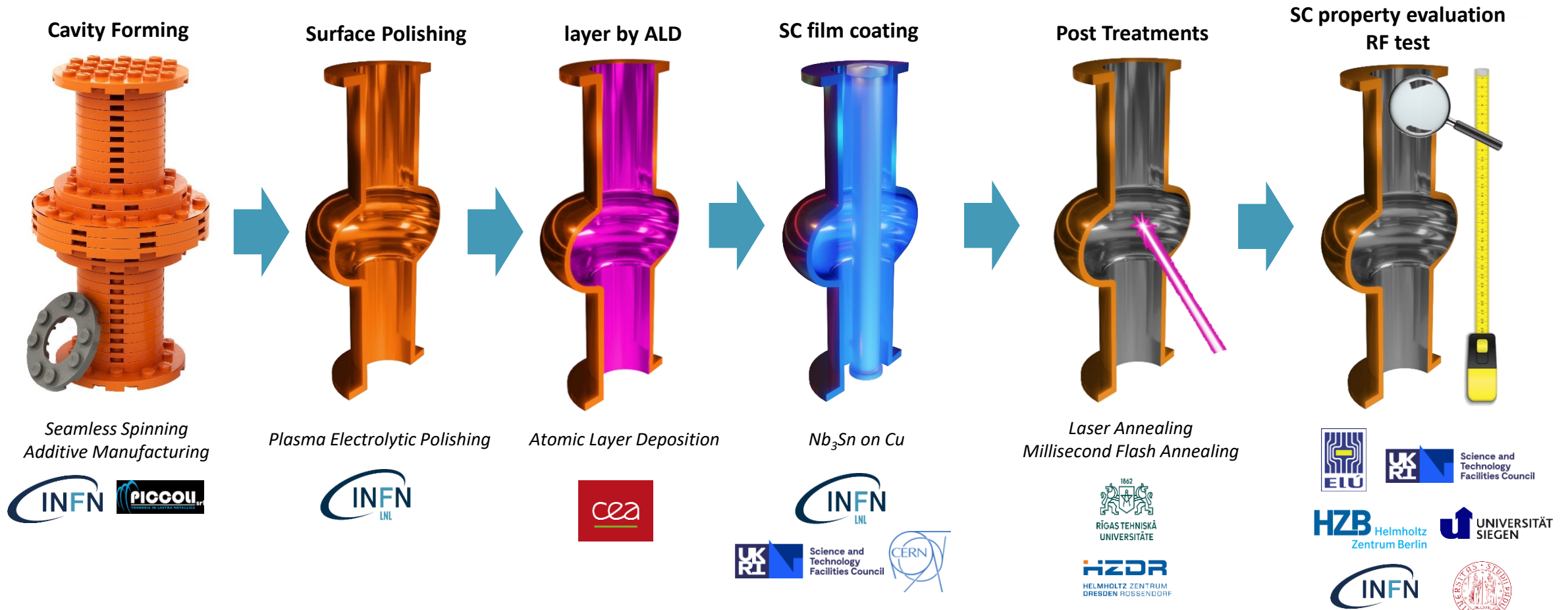
 A. M. Valente Feliciano

## Informal Partners

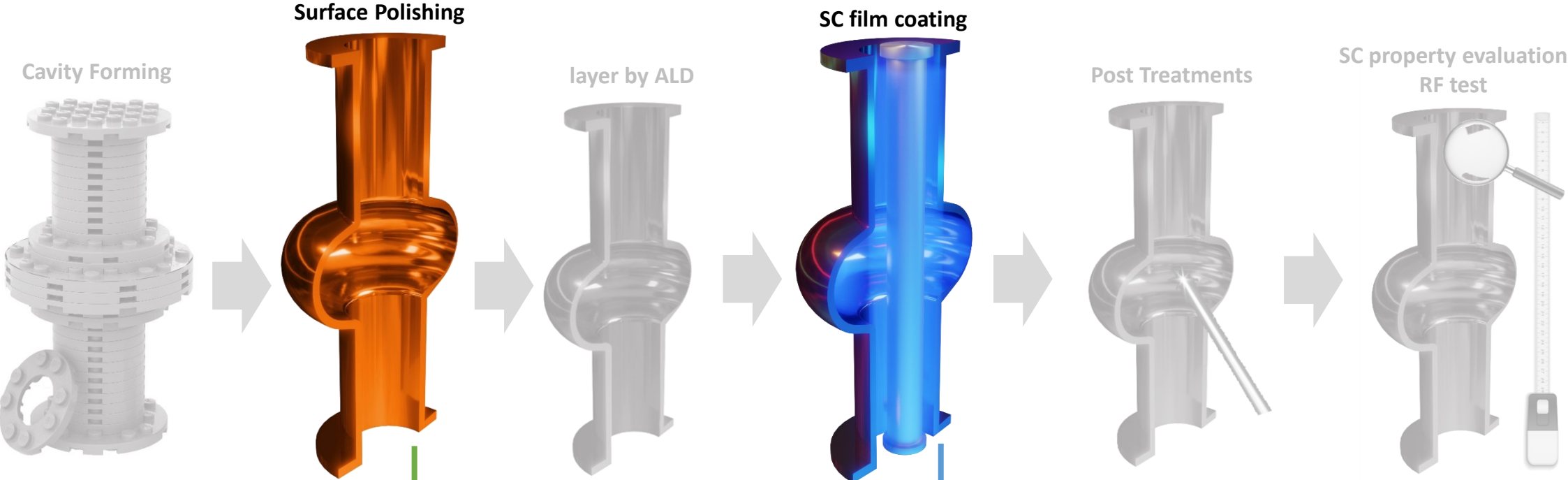




# Nb<sub>3</sub>Sn on Cu R&D activity covers all cavity production chain



# 2 Technologies in focus



Plasma  
Electrolytic  
Polishing



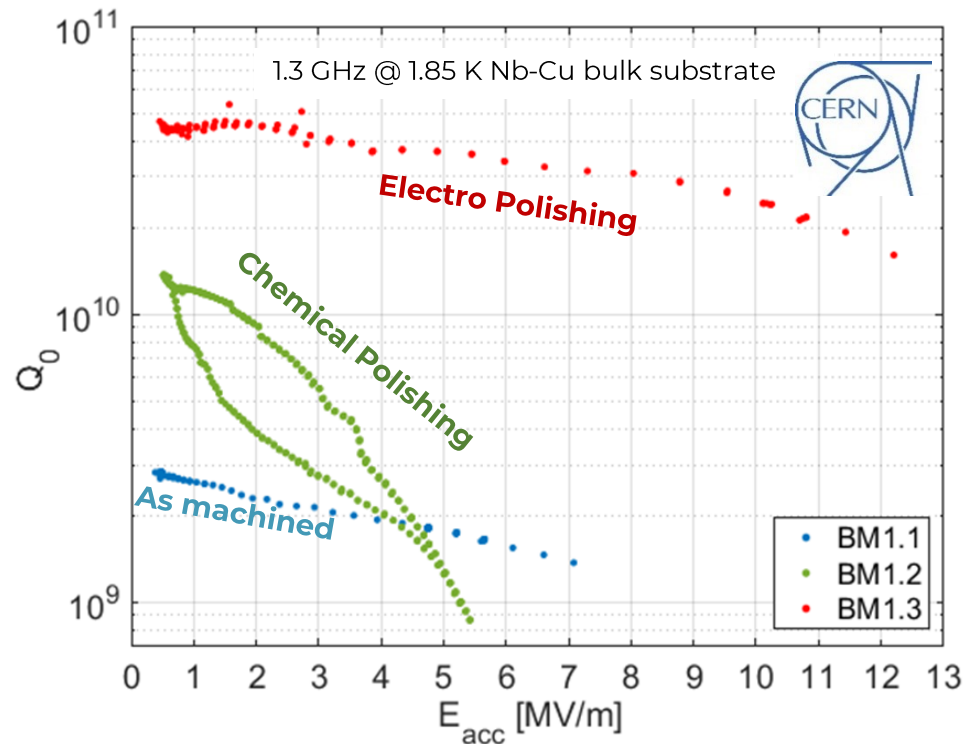
Nb<sub>3</sub>Sn on Cu  
Coatings



# Surface Polishing

## PEP

# Surface Polishing



L. Vega Cid, TTC meeting 2022 (elaborated)

## Cu substrate plays a fundamental role in SRF performances

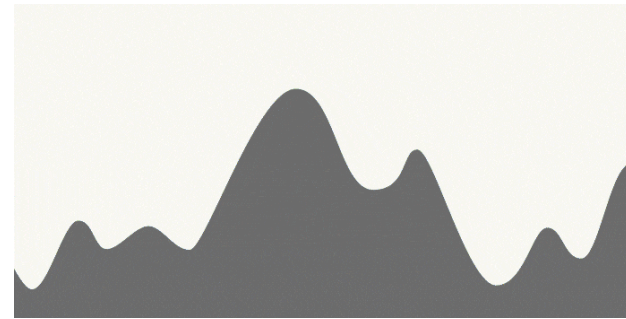
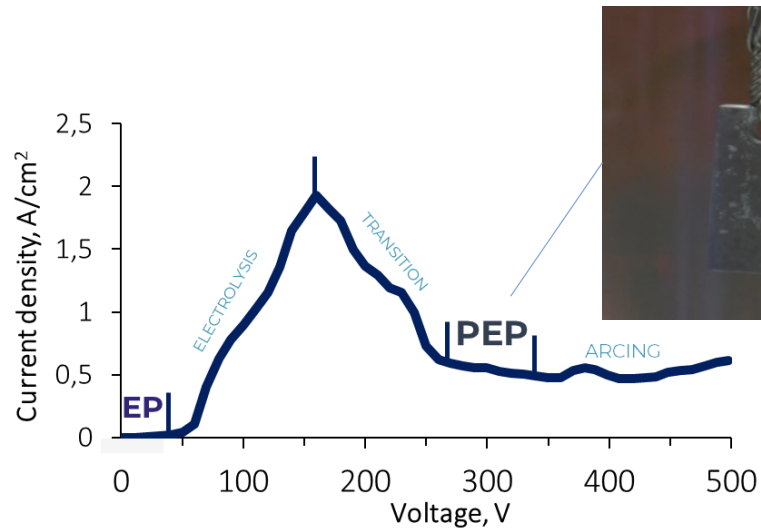
Roughness and defects reduction by **surface treatments are mandatory** for a good and uniform SRF coating

Cavity polishing requires **large amount of acids**. In particular **Nb** requires **HF** (extremely dangerous and poisoning process)

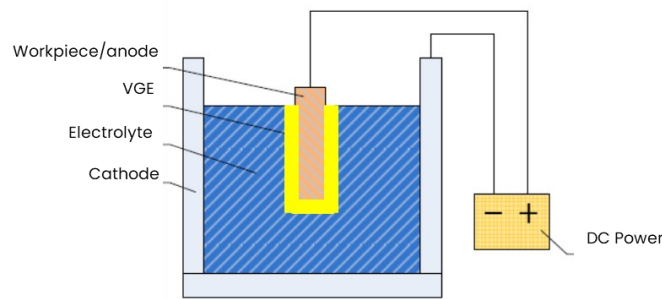




# Plasma Electrolytic Polishing PEP Mechanism



Same EP set-up  
Different regime



J. Wang et al., AMR, 2012

## Advantages



**Green**  
Diluted water solutions,  
environmentally friendly



**Fast**  
The fastest  
non-destructive  
polishing

Equal thickness removal yield  
lowest roughness among  
competitors



**Efficiency**

**Plasma  
Electrolytic  
Polishing**

Less sensitive to the  
cathode shape!  
AM compatible

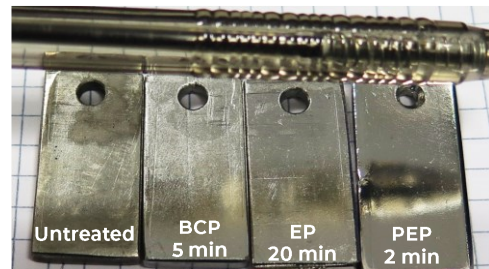
**Versatility**



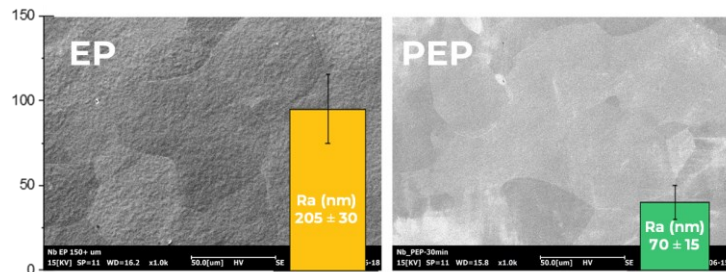
# Plasma Electrolytic Polishing **PEP** Results

1x Nb 3x Cu  
Solution Patents by INFN

## Planar samples



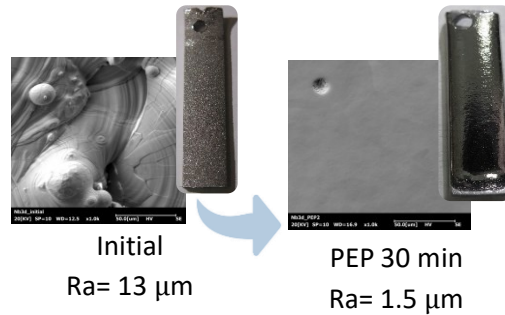
6.5  $\mu\text{m}$  removed



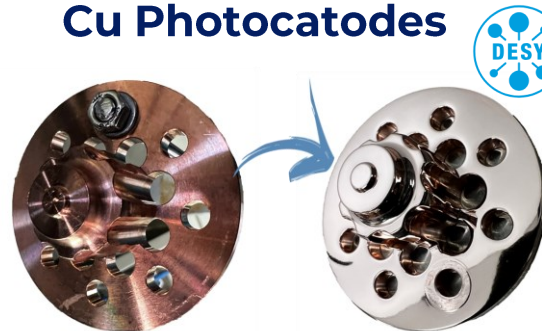
150  $\mu\text{m}$  removed in ~ 5 h

150  $\mu\text{m}$  removed in ~ 40 min

## Additive Manufacturing



## Cu Photocathodes



Ra ~ 8 nm!!!

## QPR Samples



Nb QPR polishing optimization on-going

Full Cu QPR ready for coating

HZB Helmholtz Zentrum Berlin

## 6 GHz Cu cavity



**No internal cathode!**

70  $\mu\text{m}$  removed in 10 minutes  
30 A (100  $\text{cm}^2 \rightarrow 1.3 \text{ GHz} \sim 300 \text{ A}$ )

Courtesy of E. Chyhyrnyts

# Scale up to 1.3 GHz cavity successfully done! (Aug 2024)



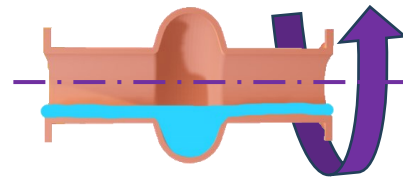
## Process Parameters

>150  $\mu\text{m}$  removed  
30 minutes! (EP  $\rightarrow$  >12 hours)  
Voltage 300 V  
Current 90-190 A (0,06 – 0,13 A/cm<sup>2</sup>)  
Surface area 1400 cm<sup>2</sup>



## Explore alternative set-up to reduce Process Power

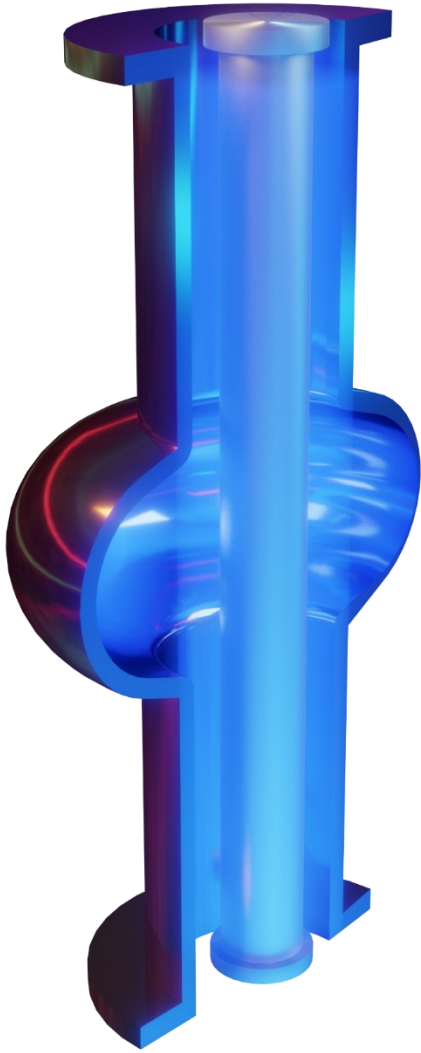
- Reduce Treated Area (rotating cavity)
- Optimizing Process Parameters (Temperature, Voltage, ...)



## Next Steps:

- Test **reproducibility**
- Validate with **RF Test** (Nb coating @CERN)  $\rightarrow$  February 2025



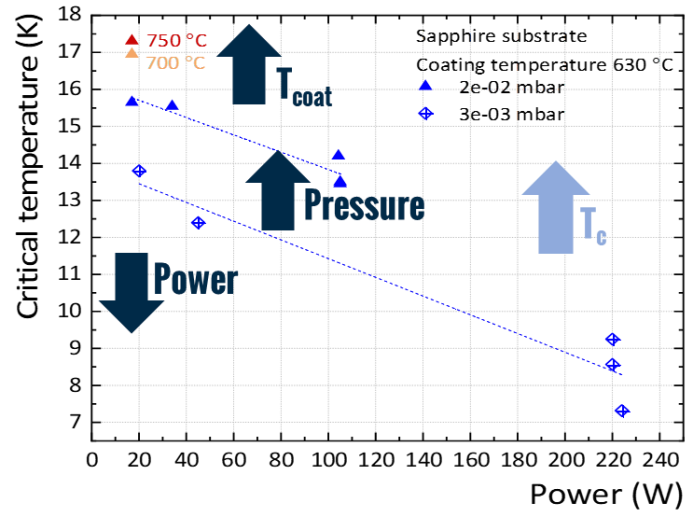


# Nb<sub>3</sub>Sn on Cu Coatings



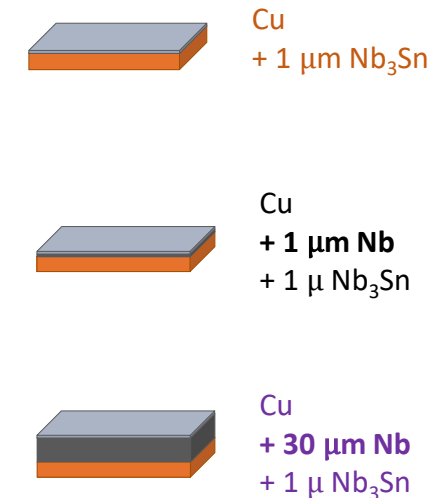
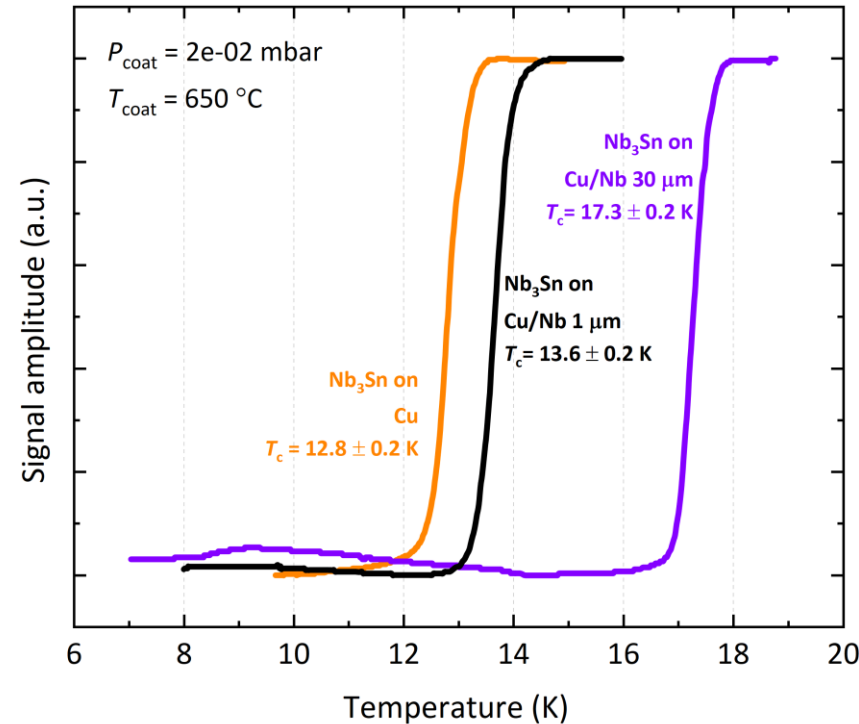
# Nb<sub>3</sub>Sn Coatings

Long R&D phase on PVD Parameter Optimization



## Optimized Coating Recipe

- Coating Parameters:
  - Pressure =  $2 \cdot 10^{-2}$  mbar
  - Power = 16 W
  - T substrate  $\geq 600$  C
- Nb Thick Barrier Layer > 30  $\mu$ m**



**A thick Nb buffer layer accommodates the Nb<sub>3</sub>Sn coating**

**Nb substrate can be used to validate Nb<sub>3</sub>Sn Coating Performances**

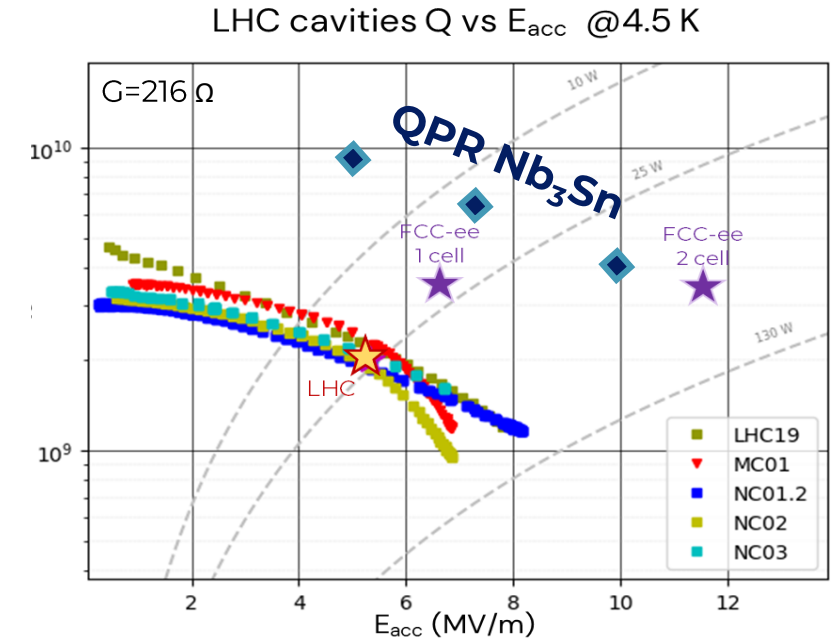
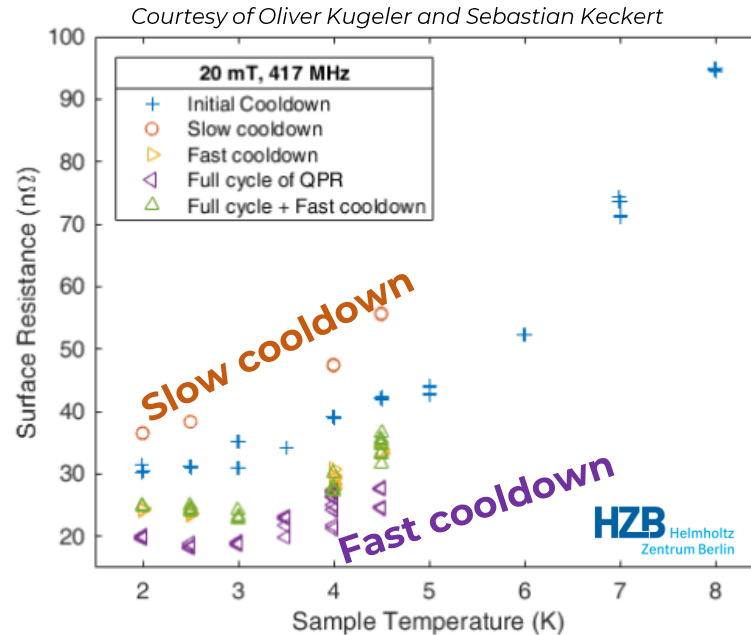
# First Nb<sub>3</sub>Sn RF Results

## (on a small Nb planar resonator)



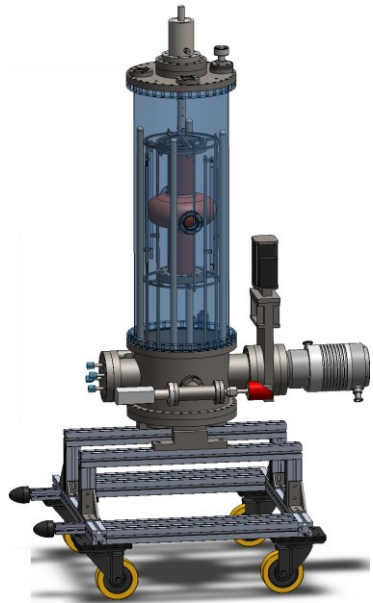
**Rs of 23 nΩ**      **Quench >70 mT**  
 @ 4.5 K, 20 mT      @ 4.5 K

- ▶ Nb<sub>3</sub>Sn coating suffer flux trapping
- ▶ Cooldown procedure influence Rs



**Equivalent to a Q of 9·10<sup>9</sup> @5 MV/m @4.5 K**  
**5 times better than LHC → FCC-ee compatible**  
*Room for improvement*

# Nb<sub>3</sub>Sn Path to Final Prototype



Nb<sub>3</sub>Sn on bulk Nb to validate coating performances (2025)  
on 1.3 GHz Elliptical Cavities (2025)



Develop Nb thick barrier/accommodation layer on 1.3 GHz Elliptical Cavities (2025)  
(proof of concept on 6 GHz cavities already done)



Nb<sub>3</sub>Sn on Cu with thick Nb coating on 1.3 GHz Elliptical Cavities (2026-2028)

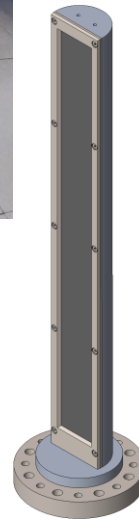
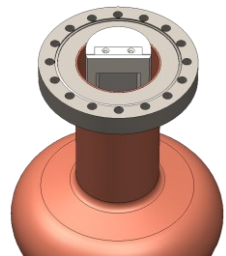
*In parallel:*

- ▶ 1.3 GHz Vacuum system ready
- ▶ Magnetron source commissioned

- ▶ Study on alternative buffer layer
- ▶ Study on flux trapping



Science and Technology Facilities Council



# Timeline

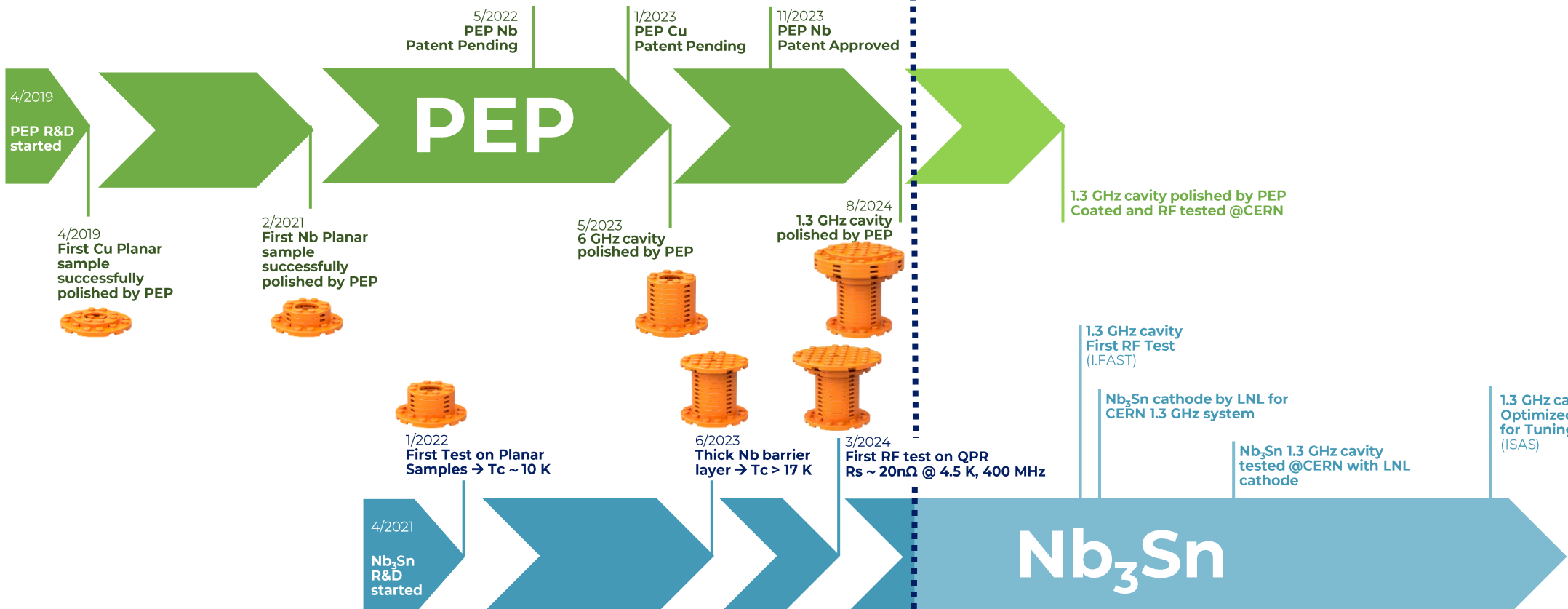
TeFeN



S/MARA



SRF cavities R&D for FCC-ee





# Conclusion

- ▶ **PEP and Nb<sub>3</sub>Sn films** are possible **game changer technologies** for SRF accelerating cavities
- ▶ **Big steps forward** in the last two years with transition from planar to 3D samples
- ▶ **Very promising results from first RF test**
- ▶ **Validation with 1.3 GHz cavities is necessary** prior to evaluating the feasibility of implementing these technologies in real accelerators
- ▶ **End of 2025** we expect to have the **first tests** available on **1.3 GHz cavities**
- ▶ **In 2028 optimized prototypes** are expected



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# Thank you!

